

## Electronic Patent Application Fee Transmittal

Application Number:	10023819
Filing Date:	21-Dec-2001
Title of Invention:	CHIP-JOIN PROCESS TO REDUCE ELONGATION MISMATCH BETWEEN THE ADHERENTS AND SEMICONDUCTOR PACKAGE MADE THEREBY
First Named Inventor:	Biju Chandran
Filer:	Joseph P. Mehrle/Anne Richards
Attorney Docket Number:	219.40779X00

Filed as Large Entity

### Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Petition fee- 37 CFR 1.17(h) (Group III)	1464	1	130	130
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Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Request for continued examination	1801	1	790	790
<b>Total in USD (\$)</b>				<b>920</b>